

December 5, 2001

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Form PTO-1149 U.S. Department of Commerce Patent and Trademark Office  INFORMATION DISCLOSURE STATEMENT BY APPLICANT	Atty. Docket No.	Serial No.
	56352USA3A	09/911,950
	Applicant	
	BARRY S. CARPENTER et al.	
	Filing Date	Group
	July 24, 2001	

## U.S. PATENT DOCUMENTS

Examiner Initial	Document Number	Date MM/DD/YY	Name	Class	Subclass	Filing Date If Appropriate
SK	4,119,363	10/10/1978	Camlibel et al.			
SK	4,186,995	02/05/1980	Schumacher			
SK	4,346,294	08/24/1982	Albaugh et al.			
SK	4,347,655	09/07/1982	Zory et al.			
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SK	5,050,953	09/24/1991	Anderson et al.			
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SK	5,774,604	06/30/1998	McDonald			
SK	5,872,880	02/16/1999	Maynard			

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Name	Document Number	Date MM/DD/YY	Country	Class	Subclass	Translation Yes/No
SK	0 010 352	4-1980	EP			Yes
SK	0 414 338 A2	2-1991	EP			Yes
SK	0 465 230 B 1	5-1995	EP			Yes
SK	0 637 765 B1	12-1998	EP			Yes

## OTHER PRIOR ART-NON PATENT LITERATURE DOCUMENTS

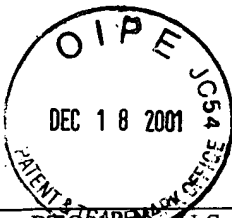
(Including Author, Title, Date, Pertinent Pages, Etc.)

SK	See page 4 section entitled "Other Prior Art - Non Patent Literature Documents"
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EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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 11/6/02



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Form PTO-540 (Rev. 10-1999) U.S. Department of Commerce Patent and Trademark Office  INFORMATION DISCLOSURE STATEMENT BY APPLICANT	Atty. Docket No.	Serial No.
	56352USA3A	09/911,950
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	July 24, 2001	

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SK	0 762 161 A1	3-1997	EP			No
SK	0 852 337 A1	7-1998	EP			Yes
SK	0 853 396 A2	7-1998	EP			Yes
SK	0 886 144 A1	12-1998	EP			Yes

#### OTHER PRIOR ART-NON PATENT LITERATURE DOCUMENTS

(Including Author, Title, Date, Pertinent Pages, Etc.)

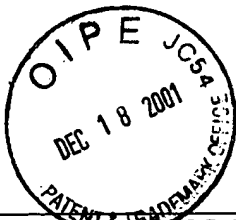
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*Section* 11/6/02





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INFORMATION DISCLOSURE STATEMENT BY APPLICANT		Applicant BARRY S. CARPENTER et al.	
		Filing Date JULY 24, 2001	Group 200001 ROOM
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SK		Butler et al., "An Embedded Overly Concept for Microsystems Packaging", 23 IEEE Transactions on Advanced Packaging 617-622 (2000).	
SK		Tilmans et al., "The Indent Reflow Sealing (IRS) Technique - A Method for the Fabrication of Sealed Cavities for MEMS Devices", 9 Journal of Microelectromechanical Systems 206-216 (2000).	
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SK		Baliga, John, "Low-Cost MEMS Packing with Cavities", 9 Journal of Microelectromechanical Systems 206 (2000).	
SK		Ramesham et al., "Challenges in Interconnection and Packaging of Microelectromechanical Systems", IEEE Electronic Components and Technology Conference (2000).	
SK		Comtois et al., "Applications for Surface-Micromachined Polysilicon Thermal Actuators and Arrays", 58 Sensors and Actuators 19-25 (1997).	
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